

## AMPMODU | AMPMODU Headers

TE Internal #: 103167-7

PCB Mount Header, Right Angle, Wire-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder,

AMPMODU Headers

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Connector System: Wire-to-Board

Number of Positions: 20

Number of Rows: 2

Centerline (Pitch): 2.54 mm [ .1 in ]
PCB Mount Orientation: Right Angle

## **Features**

## **Product Type Features**

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header

## **Configuration Features**

Connector Contact Load Condition	Fully Loaded
Number of Positions	20
Number of Rows	2
PCB Mount Orientation	Right Angle

#### **Electrical Characteristics**

Insulation Resistance	5000 ΜΩ
Dielectric Withstanding Voltage (Max)	750 Vrms

## **Body Features**

Connector Profile	Standard
Primary Product Color	Black

#### **Contact Features**

Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]



Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.43 mm[.135 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Retention	With
Mating Retention Type	Detent Window
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
PCB Thickness (Recommended)	1.4 mm[.055 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal



#### **Industry Standards**

Compatible With Agency/Standards Products	CSA
Compatible With Approved Standards Products	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	144
Packaging Method	Tray

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) SVHC > Threshold: Pb (40% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 240°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**





TE Part # 87977-8
20 MODIV HSG DR MRKD .100 POL



TE Part # 1-87456-6 20 MODIV HSG DR MRKD .100CL



TE Part # 3-87977-5
20 MODIV HSG COMP DR .100 POL



TE Part # 86177-1 20 MODIV HSG COMP DR .100CL

## Also in the Series | AMPMODU Headers



Connector Caps & Covers(1)



Connector Contacts(64)



Connector Hardware(2)



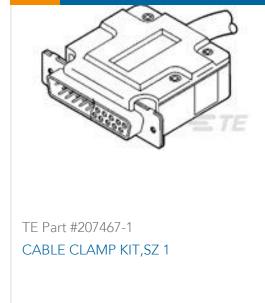
PCB Headers & Receptacles(3197)



Wire-to-Board Connector Assemblies & Housings(5)

# Customers Also Bought





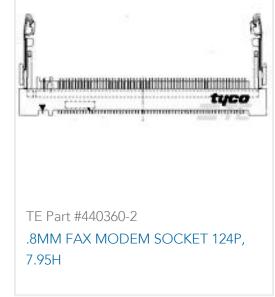




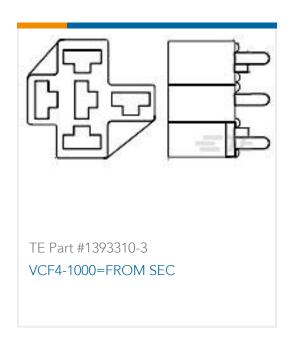












## **Documents**

## **Product Drawings**

20 MODII HDR DRRA SHRD .100CL

English

#### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_103167-7\_R.2d\_dxf.zip

English

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_103167-7\_R.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_103167-7\_R.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

## **Product Specifications**

**Product Specification** 

English